



ML22Q330/330/Q331/331

ADPCM Speech Synthesis LSI

GENERAL DESCRIPTION

The ML22330/ML22Q331/ML22Q331, which include mask ROM and Flash memory for storing speech data, respectively, are speech synthesis LSIs which can controll speech playback utilizing a serial interface.

It includes speaker amplifier and 16bit DA Converter, so it is possible to have high quality sound and solution for playback with 1chip.

• Playback Time

| Product Name | Capasitance | Maximum Playback time(s) (Fsam=8.0kHz) | | | | | |
|-----------------|-------------|----------------------------------------|------------|----------|--|--|--|
| 1 Todaet Tallie | of ROM(bit) | HQ-ADPCM | 4bitADPCM2 | 16bitPCM | | | |
| ML22Q330/330 | 620K | 620K — | | 4.9 | | | |
| ML22Q331/331 | 876K | 35.0 | 28.0 | 7.0 | | | |

• Speech sysnthesis system: 4-bit ADPCM2

8-bit/16-bit straight PCM system 8-bit nonlinear PCM system

HQ-ADPCM (*1) (ML22Q331/331) (can be specified for each phrase)

• Speech ROM capacity ML22330: 620-Kbit Mask ROM

ML22Q330: 620-Kbit Flash ML22331: 876-Kbit Mask ROM ML22Q331: 876-Kbit Flash

• Sampling frequency: 8.0/16.0 /32.0kHz, 6.4/12.8/25.6 kHz/, 10.7/21.3 kHz

(fsam can be specified in units of phrase)

Analog output: Built-in 16-bit DA converter
 Interface: Synchronous serial interface

MSB first, LSB first, or default level of synchronous clock is selectable based on ROM data

Sequencer output function: 16 typesMaximum event count: 30 events

• Input pin setting: High-impedance input (CMOS input), pull-down input, or pull-up input is selectable based

on ROM data

• Output pin setting: High-impedance output, CMOS output, Pch open drain output, Nch open drain output, or

LED drive is selectable based on ROM data

Source oscillation frequency: 4.096 MHz (Typ.)
 Power supply voltage: 2.3V to 5.5V

• Flash memory rewrite cycles 80 times (ML22Q330/Q331)

• Operating temperature range: -40°C to +85°C

Package: 30-pin plastic SSOP (SSOP30-56-0.65-Z6K9-MC)
 Product name: ML22330-xxxMB (xxx: ROM code number)
 ML22331-xxxMB (xxx: ROM code number)

ML22Q330-NNNMB/ML22Q330-xxxMB(xxx: ROM code number) ML22Q331-NNNMB/ML22Q331-xxxMB(xxx: ROM code number)

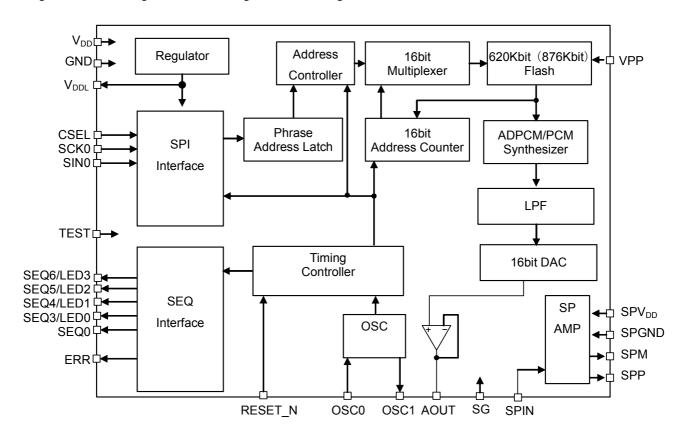


HQ-ADPCM is audio compression technology featuring high-quality sound. It was developed by "Ky's". "Ky's" is a registered trademark of Kyushu Institute of Technology, one of the national universities in Japan.



BLOCK DIAGRAM

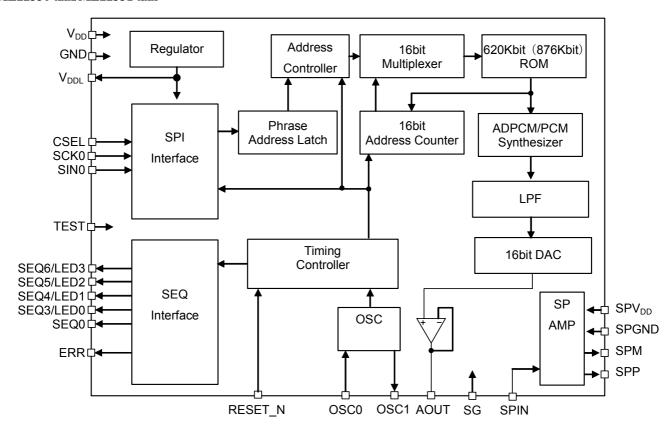
ML22Q330-NNN/ML22Q331-NNN/ML22Q330-xxx/ML22Q331-xxx



():Applies to ML22Q331



ML22330-xxx/ML22331-xxx



():Applies to ML22331



PIN CONFIGURATION (TOP VIEW)

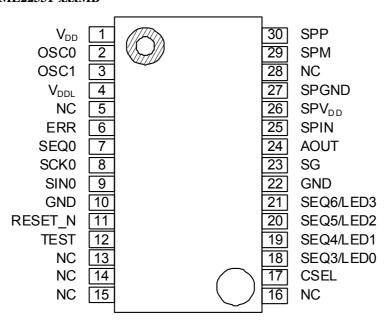
ML22Q330-NNNMB/ML22Q331-NNNMB/ML22Q330-xxxMB/ML22Q331-xxxMB

| | ſ | | 1 | |
|-----------|----|--|----|------------|
| V_{DD} | 1 | | 30 | SPP |
| OSC0 | 2 | | 29 | SPM |
| OSC1 | 3 | | 28 | NC |
| V_{DDL} | 4 | | 27 | SPGND |
| VPP | 5 | | 26 | SPV_{DD} |
| ERR | 6 | | 25 | SPIN |
| SEQ0 | 7 | | 24 | AOUT |
| SCK0 | 8 | | 23 | SG |
| SIN0 | 9 | | 22 | GND |
| GND | 10 | | 21 | SEQ6/LED3 |
| RESET_N | 11 | | 20 | SEQ5/LED2 |
| TEST | 12 | | 19 | SEQ4/LED1 |
| NC | 13 | | 18 | SEQ3/LED0 |
| NC | 14 | | 17 | CSEL |
| NC | 15 | | 16 | NC |
| | L | |] | |

NC: Unused pin

30-pin Plastic SSOP

ML22330-xxxMB/ML22331-xxxMB



NC: Unused pin

30-pin Plastic SSOP



PIN DESCRIPTIONS

| Pin No. | symbol | I/O | Description |
|----------------------|--------------------------------------------------|-----|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 11 | RESET_N | I | Place this pin at a "L" level when powered on. After the supply voltage is settled place this pin at a "H" level. |
| 17 | CSEL | I | Chip select pin. At the "L" level, SCK0 pin and SIN0 pin are available. |
| 8 | SCK0 | - 1 | Synchronous clock input pin for serial interface. |
| 9 | SIN0 | - 1 | Input pin of synchronous serial data. |
| 12 | TEST | I | Input pin for testing. Fix this pin at a "L" level (GND level). |
| 2 | OSC0 | I | Pin for connecting a crystal or a ceramic vibrator. A feed back resistor (about 1 $M\Omega$) is included between OSC0 and OSC1 pins. When a vibrator is used, place it as close to the LSI as possible. |
| 3 | OSC1 | 0 | Pin for connecting a crystal or a ceramic vibrator. When a vibrator is used, place it as close to the LSI as possible. |
| 6 | ERR | 0 | Error output pin for thermal detection and disconnection detection. If disconnection detection or a higher temperature than the judgme temperature is detected, this pin output "H". Setting event 1, operate the disconnection detection. And the 100ms "H" pulse is output right after the event start. |
| 7 | SEQ0 | 0 | Sequencer output pins. The patterns set by Mask option are output. |
| 18 19 20 21 | SEQ3/LED0 SEQ4/LED1 SEQ5/LED2 SEQ6/LED3 | 0 | Sequencer output pins. The patterns set by Mask option are output. And these pins can be set for the LED drive pins. |
| 24 | AOUT | 0 | Playback signal output pin. When you use built-in speaker amplifier, connect with the SPIN pin. |
| 5 | VPP *Note 1 | _ | Power supply pin for rewriting Flash memory. Fix this pin to GND except when rewriting Flash memory. |
| 1 | V _{DD} | _ | Digital power supply pin. Connect a capacitor of 0.1 μF or more between this pin and GND. |
| 4 | V_{DDL} | _ | Output pin of the regulator for the internal logic power supply. Connect a electrolytic capacitor of 10 uF or more and a ceramic capacitor of 0 μ F or more between the V _{DDL} and GND pins. |
| 10,22 | GND | _ | Digital ground pin. |
| 27 | SPGND | _ | Speaker amplifier ground pin. |
| 26 | SPVDD | _ | Speaker amplifier power supply pin. |
| 25 | SPIN | I | Analog input pin of internal speaker amplifier. |
| 23 | SG | 0 | Built-in speaker amplifier's reference voltage output pin. Connect a capacitor of 0.1 µF or more between this pin and GND. |
| 30 | SPP | 0 | Positive output pin of the built-in speaker amplifier. |
| 29 | SPM | 0 | Negative output pin of the built-in speaker amplifier. |

Notes: 1. Applies to ML22Q330-NNN / ML22Q331-NNN.



ABSOLUTE MAXIMUM RATINGS

(GND = SPGND = 0 V)

| | | | | CITE OF CITE OF |
|-------------------------------------|------------------|------------------------------------------------|-------------------------|-----------------|
| Parameter | Symbol | Condition | Rating | Unit |
| Digital power supply voltage | V_{DD} | | -0.3 to +7.0 | V |
| Internal logic power supply voltage | V_{DDL} | | -0.3 to +3.6 | V |
| Speaker power supply voltage | SPV_{DD} | Ta = 25 °C | -0.3 to +7.0 | V |
| Flash power supply voltage (Note 1) | VPP | | -0.3 to +9.5 | V |
| Input voltage | V_{IN} | Ta = 25 °C When JEDEC 2-layer board is mounted | -0.3 to V_{DD} +0.3 | V |
| Power dissipation | P_D | Ta = 25 °C | 861 | mW |
| Output short current | I _{SC1} | except LED drive pin, Ta = 25 °C | -12 to +11 | mA |
| , | I _{SC2} | LED drive pin, Ta = 25 °C | -12 to +20 | mA |
| Storage temperature | T _{STG} | _ | -55 to +150 | °C |

Note 1: Applies to the ML22Q330-NNN/ML22Q331-NNN.

RECOMMENDED OPERATING CONDITIONS

(GND = SPGND = 0 V)

| Parameter | Symbol | Condition | Condition Range | | | | |
|------------------------------|------------------|---------------------------|-----------------|------------|------|--------|--|
| | | _ | | 2.3 to 5.5 | | _ | |
| Digital power supply voltage | V_{DD} | ML22Q330 / ML22Q331 read | 2.3 to 5.5 | | | V | |
| | | ML22Q330 / ML22Q331 write | | 3.0 to 5.5 | | | |
| Speaker power supply voltage | SPV_{DD} | _ | 2.3 to 5.5 | | | V | |
| Flash power supply voltage | VPP | ML22Q330 / ML22Q331 write | | 7.7 to 8.3 | V | | |
| Flash memory rewrite cycles | N | ML22Q330 / ML22Q331 | | 80 | | times | |
| | T _{OP1} | ML22330 / ML22331 | | -40 to +85 | 5 | | |
| Operating temperature | T _{OP2} | ML22Q330 / ML22Q331 read | | -40 to +85 | , | °C | |
| | T _{OP3} | ML22Q330 / ML22Q331 write | 0 to +40 | | | | |
| Source oscillation frequency | f | | Min. | Тур. | Max. | MHz | |
| Source oscillation frequency | f _{OSC} | _ | 3.5 | 4.096 | 4.5 | IVIF1Z | |



ELECTRICAL CHARACTERISTICS

DC Characteristics

| DC Characteristics | | $V_{DD} = SPV_{DD} = 2.3$ | 3 to 5.5 V. GND | = SPGND | = 0 V. Ta = -40 |) to +85°C |
|-----------------------|-------------------|----------------------------------------------------------------------|----------------------|---------|---------------------|------------|
| Parameter | Symbol | Condition | Min. | Тур. | Max. | Unit |
| "H" input voltage | V _{IH} | | 0.7×V _{DD} | _ | V_{DD} | V |
| "L" voltage | V _{IL} | | 0 | _ | 0.3×V _{DD} | V |
| "H" output voltage 1 | V _{OH1} | I _{OH} = -0.5 mA CMOS output, Pch open drain selected | V _{DD} -0.5 | _ | _ | V |
| "H" output voltage 2 | V _{OH2} | I _{OH} = -100 μA OSC1 pin | V _{DD} -0.5 | _ | _ | V |
| "L" output voltage 1 | V _{OL1} | I _{OL} = 0.5 mA CMOS output, Nch open drain selected | | _ | 0.5 | V |
| "L" output voltage 2 | V _{OL2} | I _{OL} = 100 μA OSC1 pin | _ | _ | 0.5 | V |
| "L" output voltage 4 | V _{OL4} | I_{OL} = 8 mA, $V_{DD} \ge 2.3V$ When the LED drives | _ | _ | 0.5 | V |
| "H" input current 1 | I _{IH1} | $V_{IH} = V_{DD}$ | _ | _ | 1 | μA |
| "H" input current 2 | I _{IH2} | V _{IH} = V _{DD} TEST pin | 0.02 | 0.3 | 1.5 | mA |
| "L" input current 1 | I _{IL1} | $V_{IL} = GND$ | -1 | _ | _ | μA |
| "L" input current 2 | I _{IL2} | V_{IL} = GND RESET_N pin | -1.5 | -0.3 | -0.02 | mA |
| "L" input current 3 | I _{IL3} | V _{IL} = GND CSEL pin | -250 | -30 | -2 | μΑ |
| Supply current during | I _{DD1} | Non-loaded output $V_{DD} = SPV_{DD} = 3.0V$ | _ | 2.5 | 12 | - mA |
| operate | I _{DD2} | Non-loaded output $V_{DD} = SPV_{DD} = 5.0V$ | _ | 8 | 12 | IIIA |
| Supply current during | I _{DDS1} | Ta ≦40°C | _ | 0.5 | 2.0 | μΑ |
| power down | I _{DDS2} | Ta ≦ 85°C | _ | 0.5 | 8.0 | μΛ |



Analog Characteristics

 V_{DD} = SPV $_{DD}$ = 2.3 to 5.5 V, GND = SPGND = 0 V, Ta = -40 to +85°C

| Parameter | Symbol | Condition | Min. | Тур. | Max. | Unit |
|------------------------------------------------------------------|------------------|----------------------------------------------------------------------------------|-------------------------|--------------------|---------------------|------|
| AOUT output load resistance | R _{LA} | During 1/2 V _{DD} output | 10 | | _ | kΩ |
| AOUT output voltage range | V _{AO} | No output load | 1/6×V _{DD} | _ | 5/6×V _{DD} | V |
| SG output voltage | V_{SG} | _ | 0.95xV _{DD} /2 | V _{DD} /2 | 1.05xVpd/2 | V |
| SG output resistance | Rsg | _ | 57 | 96 | 135 | kΩ |
| SPM, SPP output load resistance | RLSP | _ | 8 | _ | _ | Ω |
| Speaker amplifier output power | P _{SPO} | SPV _{DD} =5.0V, f=1kHz, R _{SPO} =8 Ω , THD \ge 10% | _ | 1 | _ | W |
| Output offset voltage between SPM and SPP with no signal present | V _{OF} | SPIN-SPM gain=0dB 8Ω load | -50 | _ | 50 | mV |

AC Characteristics

 V_{DD} = SPV_{DD} = 2.3 to 5.5 V, GND = SPGND = 0 V, Ta = -40 to +85°C

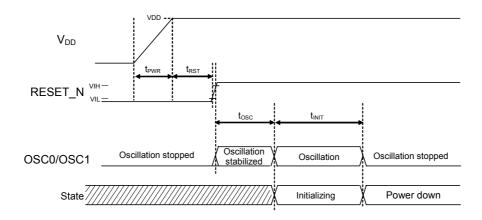
| | • ∪∪ | 2.0 to 0.0 V, CIVD | 01 011 | O V, | 14 10 | , 10 . 00 0 |
|----------------------------------------------------|----------------------------------------|----------------------------|--------|------|-------|-------------|
| Parameter | Symbol | Condition | Min. | Тур. | Max. | Unit |
| Duty cycle of source oscillation | f _{duty} | _ | 40 | 50 | 60 | % |
| RESET_N input pulse width | t _{RST} | _ | 100 | _ | _ | μS |
| Voltage startup time | t _{PWR} | _ | | _ | 10 | ms |
| Initialize time | t _{INIT} | f _{OSC} =4.096MHz | 20 | _ | 22 | ms |
| Oscillation stabilizing time | tosc | _ | _ | 2 | 20 | ms |
| SCK0 input cycle | t _{scyc} | _ | 500 | _ | _ | ns |
| SCK0 input pulse width | t _{SW} | _ | 200 | _ | _ | ns |
| Setup time of SIN0 to the rising of SCK0 | t _{SS} | _ | 50 | _ | _ | ns |
| Hold time of SIN0 to the rising of SCK0 | t _{SH} | _ | 50 | _ | _ | ns |
| Setup time of CSEL to the rising of SCK0 | t _{CSS} | _ | _ | 2 | 20 | ms |
| Hold time of CSEL to the rising of SCK0 | t_{CSH} | _ | 100 | _ | _ | ns |
| SG pin voltage stabilization time(Rising) | t _{SGR} | f _{OSC} =4.096MHz | 32 | _ | 34 | ms |
| SG pin voltage stabilization time(Falling) | t _{SGF} | f _{OSC} =4.096MHz | 64 | _ | 66 | ms |
| Pop noise elimination time | t _{POPR} t _{POPF} | f _{OSC} =4.096MHz | 40 | _ | 42 | ms |
| Disconnection judging time by the DISCONNECT event | t _{DCD} | _ | 100 | _ | _ | ms |

Load capacitance of the output pins = 55 pF (max.)



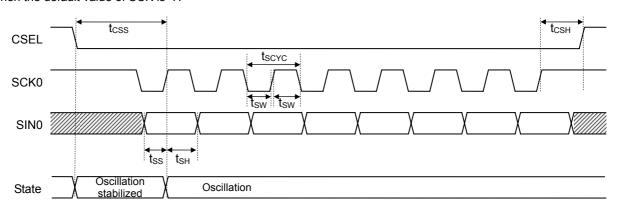
TIMING DIAGRAMS

Power On

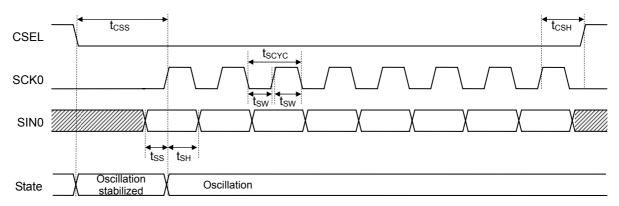


Serial Interface

· When the default value of SCK is "H"

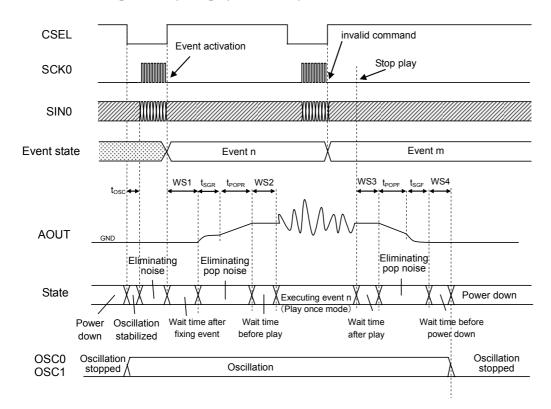


· When the default value of SCK is "L"

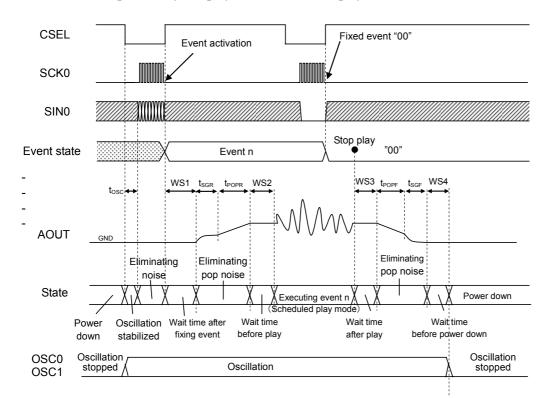




Event Control example 1 (Only one playback in Play once mode)

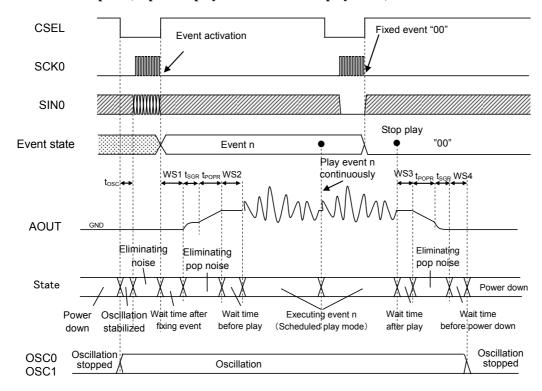


Event Control example 2 (Only one playback in Scheduled play mode)

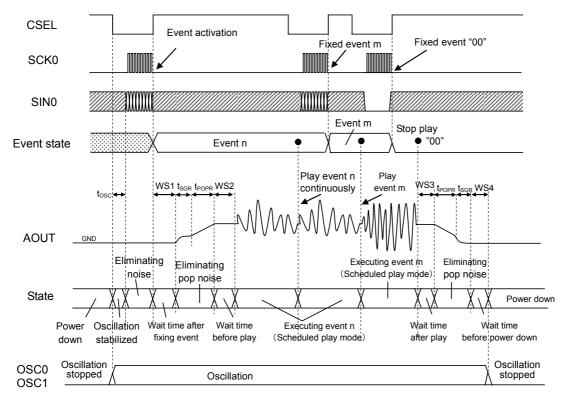




Event Control example 3 (Repetitive playback in Scheduled play mode)

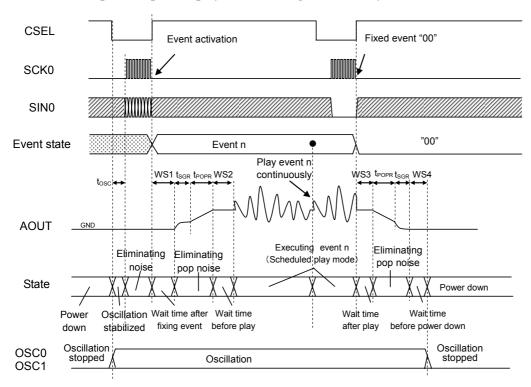


Event Control example 4 (Change in playback phrase in Scheduled play mode)

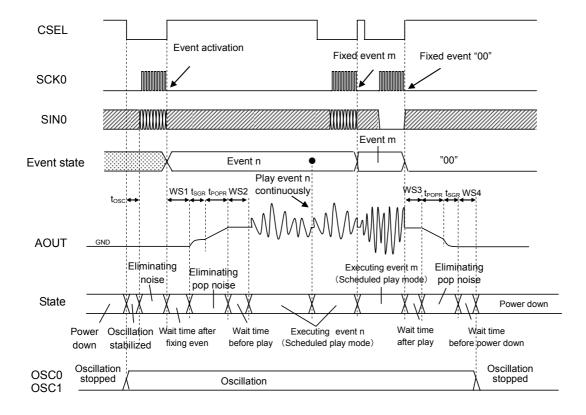




Event Control example 5 (Repetitive playback in Change immediately mode)



Event Control example 6 (Change in playback phrase in Change immediately mode)





FUNCTIONAL DESCRIPTION

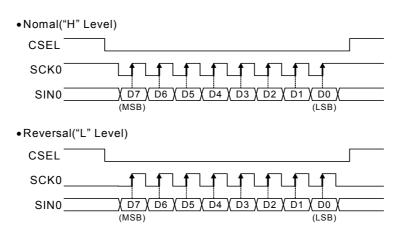
The "Speech LSI Utility" is used for the setting of an each function and the creating of ROM data. The Speech LSI Utility is dedicated software.

Synchronous Serial Command Interface

The CSEL, SCK0, SIN0 pins are used to input the event data. Driving the CSEL pin to "L" level enables the serial CPU interface. After the CSEL pin is driven to "L" level, the event data are input through the SIN0 pin from the MSB or LSB synchronized with the SCK0 clock. The event data shifts in through the SIN0 pin at the rising edge of the SCK0 clock pulse. Then, a event is executed at the rising edge of the eighth pulse of the SCK0 clock.

When setting the initial value of the SCK0 pin as "H" level, please choose "Nomal ("H" Level)" as a mask option. When setting the initial value of the SCK0 pin as "L" level, please choose "Reversal("L" Level)" as a mask option. After a event input should return the CSEL pin to "H" level.

Data input timing





Playback mode setup

Playback mode can be set up for every phrase. Playback mode is set into the ROM data. The ROM data is created using a Speech LSI Utility. The Speech LSI Utility is dedicated software.

| Playback mode | Operation |
|--------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Play Once | This mode is playback once. All the commands become invalid during playback. |
| Scheduled Play | The playback continues until the following command will be inputted, if playback starts. When the following command is inputted into playback, after playback of the present phrase is completed, the following command is executed. |
| Change Immediately | The playback continues until the following command will be inputted, if playback starts. When the following phrase is inputted into playback, playback of the present phrase is ended on the way, and playback of the following phrase starts. |

Event List

Each command is configured by the unit of byte (8-bit).

| Event | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | Description |
|----------------------------|----|----|----|----|----|----|----|----|---------------------------------------------------------------------------------------------------------------|
| Stop | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | Stop event. The Stop event becomes effective except the phrase in Play Once mode. |
| Disconnection Detection | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | Disconnection Detection event. Please input the Stop event, after you use the Disconnection Detection event. |
| | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | Phrase 02 Play event |
| | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | Phrase 03 Play event |
| | | | | | : | | | | : |
| Play | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 1 | Phrase 09 Play event |
| | 0 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | Phrase 0A Play event |
| | | | | | : | | | | : |
| | 0 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | Phrase 1F Play event |



Description of Event Functions

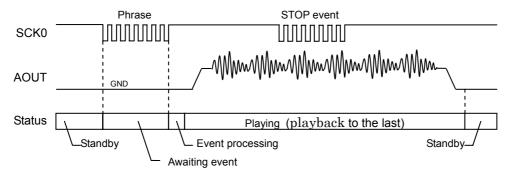
1. STOP event

| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
|---|---|---|---|---|---|---|---|
|---|---|---|---|---|---|---|---|

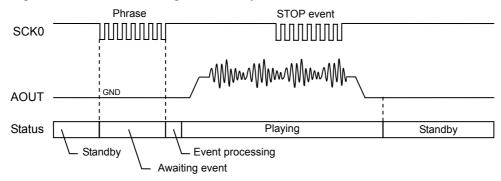
The STOP event is used to stop the repeat playback. The STOP event becomes effective except the phrase in Play Once mode. When you use Play Once mode, the STOP event is ignored.

When you use Scheduled Play mode, a phrase is played back to the last and the playback is stopped, after the STOP event is inputted. Furthermore, when you use Change Immediately mode, a phrase is not played back to the last and the playback is stopped immediately, after the STOP event is inputted.

• STOP event operation in the case of Scheduled Play mode



· STOP event operation in the case of Change Immediately mode

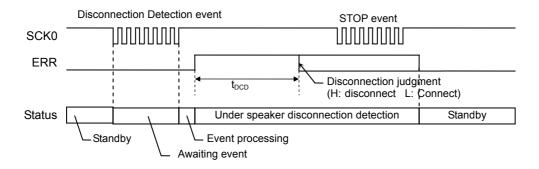




2. Disconnection Detection event

| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
|---|---|---|---|---|---|---|---|
| • | • | • | • | • | • | • | |

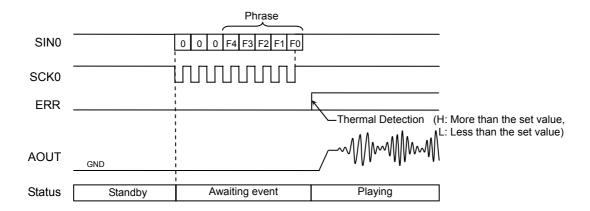
The Disconnection Detection event is used to diagnose whether the speaker is disconnected or not. When the speaker is disconnected, ERR pin outputs "L". Please input the STOP event, after you use the Disconnection Detection event.



3.Play n (n= Phrase 02∼Phrase 1F) event

| 0 | 0 | 0 | F4 | F3 | F2 | F1 | F0 |
|---|---|---|----|----|----|----|----|

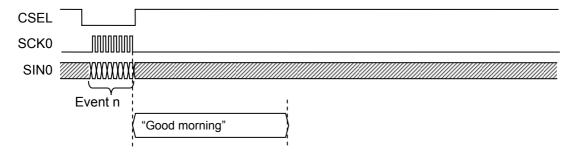
The Play n (n = Phrase 02 to Phrase 1F) event is used to start playback phrase. After inputting a PLAY n (n = Phrase 02 to 1F) event, temperature detection is carried out.





O Event Control example 1 (Only one playback in Play once mode)

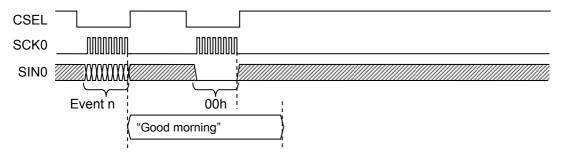
Only one event specified is executed after event activation. Operation: Control method: Input the event number by using the serial interface pins.



O Event Control example 2 (Only one playback in Scheduled play mode)

Only one specification mode is executed Operation:

Control method: Input the event number by using the serial interface pins. After event activation, input "00h" by using the serial interface pins before event execution is ended.



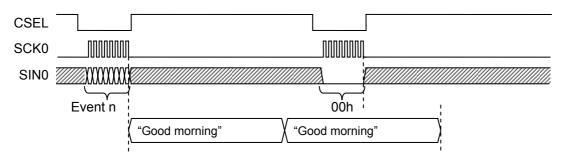
O Event Control example 3 Repetitive playback in Scheduled play mode)

Operation: Until STOP command is input, the event execution is repeated.

In the case of the event execution stop, the event execution is terminated.

Control method: Input the event number by using the serial interface pins. When desired to stop event execution, input "00h"

by using the serial interface pins.

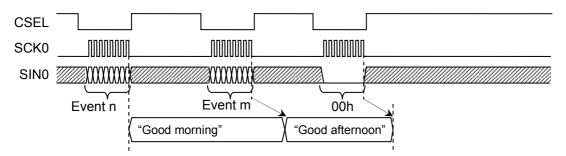




O Event Control example 4 (Change in playback phrase in Scheduled play mode)

Operation: The event execution specified first is ended and newly specified event execution is started.

Control method: Input the event number by using the serial interface pins. After event activation, input the next event number by using the serial interface pins.



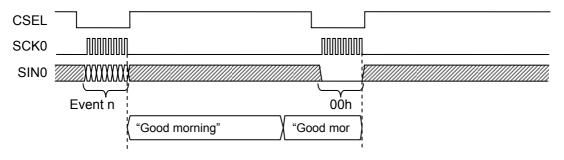
O Event Control example 5 (Repetitive playback in Change immediately mode)

Operation: Event execution is performed until "00h" in input by using the serial interface pins. The event execution

stops when "00h" is input by using serial interface pins.

Control method: Input the event number by using the serial interface pins. When desired to stop event execution, input "00h"

by using the serial interface pins.

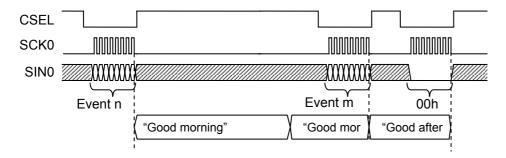


O Event Control example 6 (Change in playback phrase in Change immediately mode)

Operation: The event execution specified first is ended and newly specified event execution is started.

Control method: Input the event number by using the serial interface pins. After event activation, input the next event number

by using the serial interface pins.





Sequencer Output

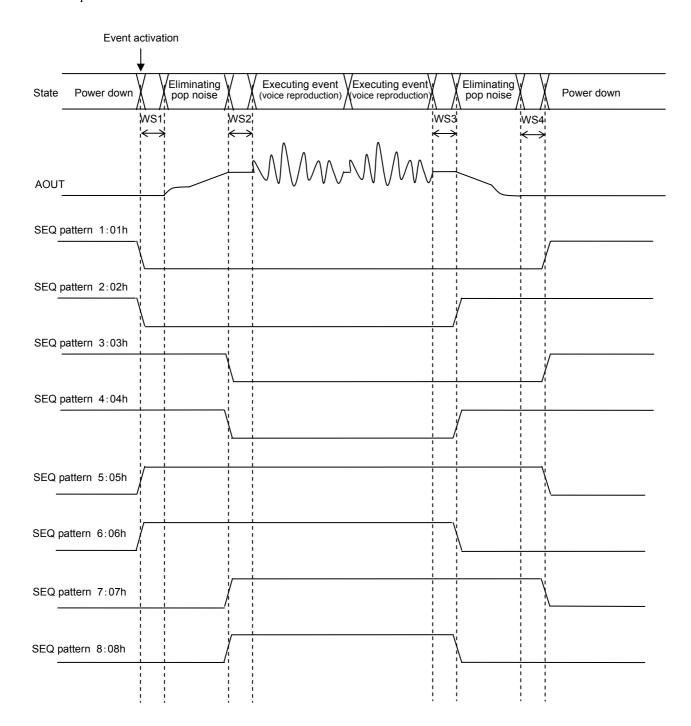
The patterns specified to the SEQ0-6 pins are output by specifying the SEQ patterns shown below in the event management area. When SEQ pattern "00h" is specified, the signals are not output from the SEQ pins.

And the SEQ0 pin can specify only the SEQ pattern 6.

The ROM data is created using a Speech LSI Utility.

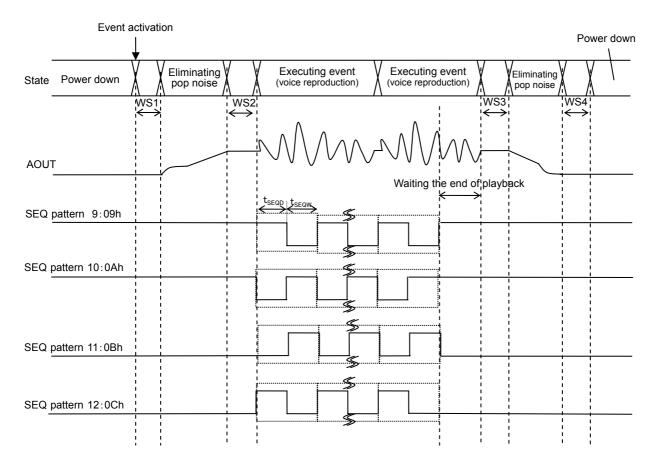
The Speech LSI Utility is dedicated software.

LEVEL output





Pulse output



The pulse output is only enaled during playback the sound. If pulse output time is higher than playback sound time, it will be SEQ output initialize level specified by Mask option.

A pulse output is output by the designated pulse width (t_{SEQW}) , delay time (t_{SEQD}) and number of times. Speech LSI Utility is used for these setting.



Pulse Width/Delay Time

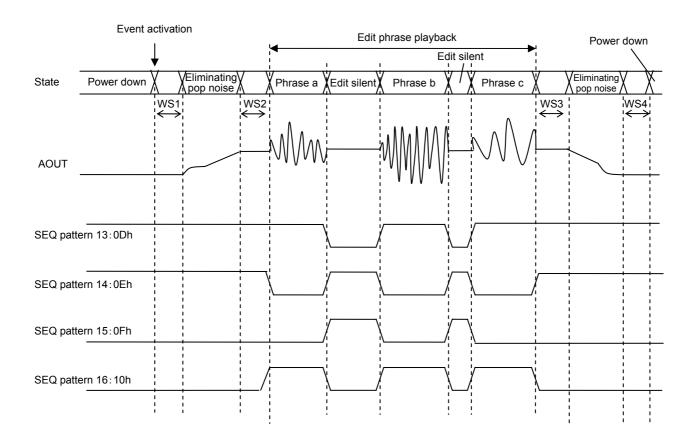
| Pulse Width/Delay Time | | | | | | | | | |
|------------------------|------------|---------|------------|---------|------------|---------|------------|---------|------------|
| Setting | Pulse | Setting | Pulse | Setting | Pulse | Setting | Pulse | Setting | Pulse |
| value | Wide/Delay | value | Wide/Delay | value | Wide/Delay | value | Wide/Delay | value | Wide/Delay |
| | Time [ms] | | Time [ms] | | Time [ms] | | Time [ms] | | Time [ms] |
| 00h | 4 | 34h | 212 | 67h | 416 | 9Ah | 620 | CDh | 824 |
| 01h | 8 | 35h | 216 | 68h | 420 | 9Bh | 624 | CEh | 828 |
| 02h | 12 | 36h | 220 | 69h | 424 | 9Ch | 628 | CFh | 832 |
| 03h | 16 | 37h | 224 | 6Ah | 428 | 9Dh | 632 | D0h | 836 |
| 04h | 20 | 38h | 228 | 6Bh | 432 | 9Eh | 636 | D1h | 840 |
| 05h | 24 | 39h | 232 | 6Ch | 436 | 9Fh | 640 | D2h | 844 |
| 06h | 28 | 3Ah | 236 | 6Dh | 440 | A0h | 644 | D3h | 848 |
| 07h | 32 | 3Bh | 240 | 6Eh | 444 | A1h | 648 | D4h | 852 |
| 08h | 36 | 3Ch | 244 | 6Fh | 448 | A2h | 652 | D5h | 856 |
| 09h | 40 | 3Dh | 248 | 70h | 452 | A3h | 656 | D6h | 860 |
| 0Ah | 44 | 3Eh | 252 | 71h | 456 | A4h | 660 | D7h | 864 |
| 0Bh | 48 | 3Fh | 256 | 72h | 460 | A5h | 664 | D8h | 868 |
| 0Ch | 52 | 40h | 260 | 73h | 464 | A6h | 668 | D9h | 872 |
| 0Dh | 56 | 41h | 264 | 74h | 468 | A7h | 672 | DAh | 876 |
| 0Eh | 60 | 42h | 268 | 75h | 472 | A8h | 676 | DBh | 880 |
| 0Fh | 64 | 43h | 272 | 76h | 476 | A9h | 680 | DCh | 884 |
| 10h | 68 | 44h | 276 | 77h | 480 | AAh | 684 | DDh | 888 |
| 11h | 72 | 45h | 280 | 78h | 484 | ABh | 688 | DEh | 892 |
| 12h | 76 | 46h | 284 | 79h | 488 | ACh | 692 | DFh | 896 |
| 13h | 80 | 47h | 288 | 7Ah | 492 | ADh | 696 | E0h | 900 |
| 14h | 84 | 48h | 292 | 7Bh | 496 | AEh | 700 | E1h | 904 |
| 15h | 88 | 49h | 296 | 7Ch | 500 | AFh | 704 | E2h | 908 |
| 16h | 92 | 4Ah | 300 | 7Dh | 504 | B0h | 708 | E3h | 912 |
| 17h | 96 | 4Bh | 304 | 7Eh | 508 | Blh | 712 | E4h | 916 |
| 18h | 100 | 4Ch | 308 | 7Fh | 512 | B2h | 716 | E5h | 920 |
| 19h | 104 | 4Dh | 312 | 80h | 516 | B3h | 720 | E6h | 924 |
| 1Ah | 108 | 4Eh | 316 | 81h | 520 | B4h | 724 | E7h | 928 |
| 1Bh | 112 | 4Fh | 320 | 82h | 524 | B5h | 728 | E8h | 932 |
| 1Ch | 116 | 50h | 324 | 83h | 528 | B6h | 732 | E9h | 936 |
| 1Dh | 120 | 51h | 328 | 84h | 532 | B7h | 736 | EAh | 940 |
| 1Eh | 124 | 52h | 332 | 85h | 536 | B8h | 740 | EBh | 944 |
| 1Fh | 128 | 53h | 336 | 86h | 540 | B9h | 744 | ECh | 948 |
| 20h | 132 | 54h | 340 | 87h | 544 | BAh | 748 | EDh | 952 |
| 21h | 136 | 55h | 344 | 88h | 548 | BBh | 752 | EEh | 956 |
| 22h | 140 | 56h | 348 | 89h | 552 | BCh | 756 | EFh | 960 |
| 23h | 144 | 57h | 352 | 8Ah | 556 | BDh | 760 | F0h | 964 |
| 24h | 148 | 58h | 356 | 8Bh | 560 | BEh | 764 | F1h | 968 |
| 25h | 152 | 59h | 360 | 8Ch | 564 | BFh | 768 | F2h | 972 |
| 26h | 156 | 5Ah | 364 | 8Dh | 568 | C0h | 772 | F3h | 976 |
| 27h | 160 | 5Bh | 368 | 8Eh | 572 | C1h | 776 | F4h | 980 |
| 28h | 164 | 5Ch | 372 | 8Fh | 576 | C2h | 780 | F5h | 984 |
| 29h | 168 | 5Dh | 376 | 90h | 580 | C3h | 784 | F6h | 988 |
| 2Ah | 172 | 5Eh | 380 | 91h | 584 | C4h | 788 | F7h | 992 |
| 2Bh | 176 | 5Fh | 384 | 92h | 588 | C5h | 792 | F8h | 996 |
| 2Ch | 180 | 60h | 388 | 93h | 592 | C6h | 796 | F9h | 1000 |
| 2Dh | 184 | 61h | 392 | 94h | 596 | C7h | 800 | FAh | 1004 |
| 2Eh | 188 | 62h | 396 | 95h | 600 | C8h | 804 | FBh | 1008 |
| 2Fh | 192 | 63h | 400 | 96h | 604 | C9h | 808 | FCh | 1012 |
| 30h | 196 | 64h | 404 | 97h | 608 | CAh | 812 | FDh | 1016 |
| 31h | 200 | 65h | 408 | 98h | 612 | CBh | 816 | FEh | 1020 |
| 32h | 204 | 66h | 412 | 99h | 616 | CCh | 820 | FFh | 1024 |
| 33h | 208 | | | | | | | | |



| Number of repetition | | | | | | | | | | | |
|----------------------|-------|---------------|-------|---------------|-------|---------------|-------|---------------|-------|---------------|-------|
| Setting value | times | Setting value | times | Setting value | times | Setting value | times | Setting value | times | Setting value | times |
| 00h | 1 | 2Bh | 44 | 56h | 87 | 81h | 130 | ACh | 173 | D6h | 215 |
| 01h | 2 | 2Ch | 45 | 57h | 88 | 82h | 131 | ADh | 174 | D7h | 216 |
| 02h | 3 | 2Dh | 46 | 58h | 89 | 83h | 132 | AEh | 175 | D8h | 217 |
| 03h | 4 | 2Eh | 47 | 59h | 90 | 84h | 133 | AFh | 176 | D9h | 218 |
| 04h | 5 | 2Fh | 48 | 5Ah | 91 | 85h | 134 | B0h | 177 | DAh | 219 |
| 05h | 6 | 30h | 49 | 5Bh | 92 | 86h | 135 | B1h | 178 | DBh | 220 |
| 06h | 7 | 31h | 50 | 5Ch | 93 | 87h | 136 | B2h | 179 | DCh | 221 |
| 07h | 8 | 32h | 51 | 5Dh | 94 | 88h | 137 | B3h | 180 | DDh | 222 |
| 08h | 9 | 33h | 52 | 5Eh | 95 | 89h | 138 | B4h | 181 | DEh | 223 |
| 09h | 10 | 34h | 53 | 5Fh | 96 | 8Ah | 139 | B5h | 182 | DFh | 224 |
| 0Ah | 11 | 35h | 54 | 60h | 97 | 8Bh | 140 | B6h | 183 | E0h | 225 |
| 0Bh | 12 | 36h | 55 | 61h | 98 | 8Ch | 141 | B7h | 184 | E1h | 226 |
| 0Ch | 13 | 37h | 56 | 62h | 99 | 8Dh | 142 | B8h | 185 | E2h | 227 |
| 0Dh | 14 | 38h | 57 | 63h | 100 | 8Eh | 143 | B9h | 186 | E3h | 228 |
| 0Eh | 15 | 39h | 58 | 64h | 101 | 8Fh | 144 | BAh | 187 | E4h | 229 |
| 0Fh | 16 | 3Ah | 59 | 65h | 102 | 90h | 145 | BBh | 188 | E5h | 230 |
| 10h | 17 | 3Bh | 60 | 66h | 103 | 91h | 146 | BCh | 189 | E6h | 231 |
| 11h | 18 | 3Ch | 61 | 67h | 104 | 92h | 147 | BDh | 190 | E7h | 232 |
| 12h | 19 | 3Dh | 62 | 68h | 105 | 93h | 148 | BEh | 191 | E8h | 233 |
| 13h | 20 | 3Eh | 63 | 69h | 106 | 94h | 149 | BFh | 192 | E9h | 234 |
| 14h | 21 | 3Fh | 64 | 6Ah | 107 | 95h | 150 | C0h | 193 | EAh | 235 |
| 15h | 22 | 40h | 65 | 6Bh | 108 | 96h | 151 | C1h | 194 | EBh | 236 |
| 16h | 23 | 41h | 66 | 6Ch | 109 | 97h | 152 | C2h | 195 | ECh | 237 |
| 17h | 24 | 42h | 67 | 6Dh | 110 | 98h | 153 | C3h | 196 | EDh | 238 |
| 18h | 25 | 43h | 68 | 6Eh | 111 | 99h | 154 | C4h | 197 | EEh | 239 |
| 19h | 26 | 44h | 69 | 6Fh | 112 | 9Ah | 155 | C5h | 198 | EFh | 240 |
| 1Ah | 27 | 45h | 70 | 70h | 113 | 9Bh | 156 | C6h | 199 | F0h | 241 |
| 1Bh | 28 | 46h | 71 | 71h | 114 | 9Ch | 157 | C7h | 200 | F1h | 242 |
| 1Ch | 29 | 47h | 72 | 72h | 115 | 9Dh | 158 | C8h | 201 | F2h | 243 |
| 1Dh | 30 | 48h | 73 | 73h | 116 | 9Eh | 159 | C9h | 202 | F3h | 244 |
| 1Eh | 31 | 49h | 74 | 74h | 117 | 9Fh | 160 | CAh | 203 | F4h | 245 |
| 1Fh | 32 | 4Ah | 75 | 75h | 118 | A0h | 161 | CBh | 204 | F5h | 246 |
| 20h | 33 | 4Bh | 76 | 76h | 119 | A1h | 162 | CCh | 205 | F6h | 247 |
| 21h | 34 | 4Ch | 77 | 77h | 120 | A2h | 163 | CDh | 206 | F7h | 248 |
| 22h | 35 | 4Dh | 78 | 78h | 121 | A3h | 164 | CEh | 207 | F8h | 249 |
| 23h | 36 | 4Eh | 79 | 79h | 122 | A4h | 165 | CFh | 208 | F9h | 250 |
| 24h | 37 | 4Fh | 80 | 7Ah | 123 | A5h | 166 | D0h | 209 | FAh | 251 |
| 25h | 38 | 50h | 81 | 7Bh | 124 | A6h | 167 | D1h | 210 | FBh | 252 |
| 26h | 39 | 51h | 82 | 7Ch | 125 | A7h | 168 | D2h | 211 | FCh | 253 |
| 27h | 40 | 52h | 83 | 7Dh | 126 | A8h | 169 | D3h | 212 | FDh | 254 |
| 28h | 41 | 53h | 84 | 7Eh | 127 | A9h | 170 | D4h | 213 | FEh | 255 |
| 29h | 42 | 54h | 85 | 7Fh | 128 | AAh | 171 | D5h | 214 | FFh | 256 |
| 2Ah | 43 | 55h | 86 | 80h | 129 | ABh | 172 | | | | |



Edit silent/sound detection output with edit playback



In the edit silent section, a gap as 2.5ms is produced between a setting value and an actual value.



Specific pattern

SEQ pattern 1: 01h

The "L" level is output in time the event activation. In time WS1 after that, and start the POP noise elimination. In time WS2 after that, and play the sound. In time WS3 after that, and start the POP noise elimination. In time WS4 after that, the "H" level is output.

SEQ pattern 2: 02h

The "L" level is output in time the event activation. In time WS1 after that, and start the POP noise elimination. In time WS2 after that, and play the sound. After that, the "H" level is output. In time WS3 after that, and start the POP noise elimination.

SEQ pattern 3: 03h

The "L" level is output after the event activation and POP noise elimination. In time WS2 after that, and play the sound. In time WS3 after that, and start the POP noise elimination. In time WS4 after that, the "H" level is output.

SEQ pattern 4: 04h

The "L" level is output after the event activation and POP noise elimination. In time WS2 after that, and play the sound. After that, the "H" level is output. In time t_{SEQD3} after that, and start the POP noise elimination.

SEQ pattern 5: 05h

The "H" level is output in time the event activation. In time WS1 after that, and start the POP noise elimination. In time WS2 after that, and play the sound. In time WS3 after that, and start the POP noise elimination. In time WS4 after that, the "L" level is output.

SEQ pattern 6: 06h

The "H" level is output in time the event activation. In time WS1 after that, and start the POP noise elimination. In time WS2 after that, and play the sound. After that, the "L" level is output. In time WS3 after that, and start the POP noise elimination.

SEQ pattern 7: 07h

The "H" level is output after the event activation and POP noise elimination. In time WS2 after that, and play the sound. In time WS3 after that, and start the POP noise elimination. In time WS4 after that, the "L" level is output.

SEQ pattern 8: 08h

The "H" level is output after the event activation and POP noise elimination. In time WS2 after that, and play the sound. After that, the "L" level is output. In time t_{SEQD3} after that, and start the POP noise elimination.



SEQ pattern 9 to 12: 09h to 0Ch

While executing event, the pulses having width tSEQW and period $t_{SEQD} + t_{SEQW}$ are output by the set cycles.

* If the time of pulses is longer than the time of play sound, and have SEQ output initialize level specified by Mask option after play the sound.

SEQ pattern 13, 16: 0Dh, 0Fh

The "L" level is output when edited silence is played back and the "H" level is output when edited phrases are played back.

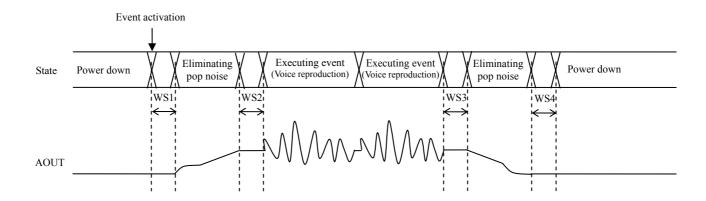
SEQ pattern 14, 15: 0Eh, 10h

The "H" level is output when edited silence is played back and the "L" level is output when edited phrases are played back.



Wait time setting before and after playback (WS1, WS2, WS3, WS4)

Each phrase can set up the wait time before and after playback. It is set into the ROM. The ROM data is created using a Speech LSI Utility. The Speech LSI Utility is dedicated software.



WS1: Time after inputting a phrase address, until SPP/SPM pins are enabled.

WS2: Time after SPP/SPM pins are enabled, until playback is started.

WS3: Time after playback is completed, until SPP/SPM pins are disabled.

WS4: Time after SPP/SPM pins are disabled, until it will be in a standby state.

WS1-WS4 can be arbitrarily set up between 0 to 1020ms (4ms unit).



Wait time setting before and after playback (WS1, WS2, WS3, WS4)

| Wait time sett | ing before a | nd after pla | yback (WS1 | , WS2, WS | S3, WS4) | | | | |
|----------------|--------------|--------------|------------|-----------|-----------|---------|-----------|---------|-----------|
| Setting | wait time | Setting | wait time | Setting | wait time | Setting | wait time | Setting | wait time |
| value | [ms] | value | [ms] | value | [ms] | value | [ms] | value | [ms] |
| 00h | 0 | 34h | 208 | 67h | 412 | 9Ah | 616 | CDh | 820 |
| 01h | 4 | 35h | 212 | 68h | 416 | 9Bh | 620 | CEh | 824 |
| 02h | 8 | 36h | 216 | 69h | 420 | 9Ch | 624 | CFh | 828 |
| 03h | 12 | 37h | 220 | 6Ah | 424 | 9Dh | 628 | D0h | 832 |
| 04h | 16 | 38h | 224 | 6Bh | 428 | 9Eh | 632 | D1h | 836 |
| 05h | 20 | 39h | 228 | 6Ch | 432 | 9Fh | 636 | D2h | 840 |
| 06h | 24 | 3Ah | 232 | 6Dh | 436 | A0h | 640 | D3h | 844 |
| 07h | 28 | 3Bh | 236 | 6Eh | 440 | Alh | 644 | D4h | 848 |
| 08h | 32 | 3Ch | 240 | 6Fh | 444 | A2h | 648 | D5h | 852 |
| 09h | 36 | 3Dh | 244 | 70h | 448 | A3h | 652 | D6h | 856 |
| 0Ah | 40 | 3Eh | 248 | 71h | 452 | A4h | 656 | D7h | 860 |
| 0Bh | 44 | 3Fh | 252 | 72h | 456 | A5h | 660 | D8h | 864 |
| 0Ch | 48 | 40h | 256 | 73h | 460 | A6h | 664 | D9h | 868 |
| 0Dh | 52 | 41h | 260 | 74h | 464 | A7h | 668 | DAh | 872 |
| 0Eh | 56 | 42h | 264 | 75h | 468 | A8h | 672 | DBh | 876 |
| 0Fh | 60 | 43h | 268 | 76h | 472 | A9h | 676 | DCh | 880 |
| 10h | 64 | 44h | 272 | 77h | 476 | AAh | 680 | DDh | 884 |
| 11h | 68 | 45h | 276 | 78h | 480 | ABh | 684 | DEh | 888 |
| 12h | 72 | 46h | 280 | 79h | 484 | ACh | 688 | DFh | 892 |
| 13h | 76 | 47h | 284 | 7Ah | 488 | ADh | 692 | E0h | 896 |
| 14h | 80 | 48h | 288 | 7Bh | 492 | AEh | 696 | E1h | 900 |
| 15h | 84 | 49h | 292 | 7Ch | 496 | AFh | 700 | E2h | 904 |
| 16h | 88 | 4Ah | 296 | 7Dh | 500 | B0h | 704 | E3h | 908 |
| 17h | 92 | 4Bh | 300 | 7Eh | 504 | Blh | 708 | E4h | 912 |
| 18h | 96 | 4Ch | 304 | 7Fh | 508 | B2h | 712 | E5h | 916 |
| 19h | 100 | 4Dh | 308 | 80h | 512 | B3h | 716 | E6h | 920 |
| 1Ah | 104 | 4Eh | 312 | 81h | 516 | B4h | 720 | E7h | 924 |
| 1Bh | 108 | 4Fh | 316 | 82h | 520 | B5h | 724 | E8h | 928 |
| 1Ch | 112 | 50h | 320 | 83h | 524 | B6h | 728 | E9h | 932 |
| 1Dh | 116 | 51h | 324 | 84h | 528 | B7h | 732 | EAh | 936 |
| 1Eh | 120 | 52h | 328 | 85h | 532 | B8h | 736 | EBh | 940 |
| 1Fh | 124 | 53h | 332 | 86h | 536 | B9h | 740 | ECh | 944 |
| 20h | 128 | 54h | 336 | 87h | 540 | BAh | 744 | EDh | 948 |
| 21h | 132 | 55h | 340 | 88h | 544 | BBh | 748 | EEh | 952 |
| 22h | 136 | 56h | 344 | 89h | 548 | BCh | 752 | EFh | 956 |
| 23h | 140 | 57h | 348 | 8Ah | 552 | BDh | 756 | F0h | 960 |
| 24h | 144 | 58h | 352 | 8Bh | 556 | BEh | 760 | F1h | 964 |
| 25h | 148 | 59h | 356 | 8Ch | 560 | BFh | 764 | F2h | 968 |
| 26h | 152 | 5Ah | 360 | 8Dh | 564 | C0h | 768 | F3h | 972 |
| 27h | 156 | 5Bh | 364 | 8Eh | 568 | C1h | 772 | F4h | 976 |
| 28h | 160 | 5Ch | 368 | 8Fh | 572 | C2h | 776 | F5h | 980 |
| 29h | 164 | 5Dh | 372 | 90h | 576 | C3h | 780 | F6h | 984 |
| 2Ah | 168 | 5Eh | 376 | 91h | 580 | C4h | 784 | F7h | 988 |
| 2Bh | 172 | 5Fh | 380 | 92h | 584 | C5h | 788 | F8h | 992 |
| 2Ch | 176 | 60h | 384 | 93h | 588 | C6h | 792 | F9h | 996 |
| 2Dh | 180 | 61h | 388 | 94h | 592 | C7h | 796 | FAh | 1000 |
| 2Eh | 184 | 62h | 392 | 95h | 596 | C8h | 800 | FBh | 1004 |
| 2Fh | 188 | 63h | 396 | 96h | 600 | C9h | 804 | FCh | 1008 |
| 30h | 192 | 64h | 400 | 97h | 604 | CAh | 808 | FDh | 1012 |
| 31h | 196 | 65h | 404 | 98h | 608 | CBh | 812 | FEh | 1016 |
| 32h | 200 | 66h | 408 | 99h | 612 | CCh | 816 | FFh | 1020 |
| 33h | 204 | | | | | | | | |



And volume setting is as follows.

Each phrase can set up the volume setup. It is set into the ROM. The ROM data is created using a Speech LSI Utility. The Speech LSI Utility is dedicated software.

| Setting value | Volume [dB] | Setting value | Volume [dB] | Setting value | Volume [dB] |
|---------------|-------------|---------------|-------------|---------------|-------------|
| 00h | +2.98 | 0Ah | -0.41 | 15h | -6.87 |
| 01h | +2.70 | 0Bh | -0.83 | 16h | -7.79 |
| 02h | +2.40 | 0Ch | -1.28 | 17h | -8.82 |
| 03h | +2.10 | 0Dh | -1.75 | 18h | -9.99 |
| 04h | +1.78 | 0Eh | -2.25 | 19h | -11.34 |
| 05h | +1.45 | 0Fh | -2.77 | 1Ah | -12.94 |
| 06h | +1.11 | 10h | -3.34 | 1Bh | -14.90 |
| 07h | +0.76 | 11h | -3.94 | 1Ch | -17.44 |
| 08h | +0.39 | 12h | -4.58 | 1Dh | -21.04 |
| 09h | +0.00 | 13h | -5.28 | 1Eh | -27.31 |
| • | | 14h | -6.04 | 1Fh | OFF |



Setting of Mask Option

The following table shows the items which can be set by using the Mask option (ROM data):

During initialization processing after power on, mask option data are transferd automatically to each setting. The ROM data is created using a Speech LSI Utility.

The Speech LSI Utility is dedicated software.

| Function | Description | The item of "speech LSI Utility" | | |
|-----------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------|--|--|
| Setting of the internal speaker amplifier | Use or unuse of the internal speaker amplifier selectable | Use of Speaker AMP | | |
| Setting of thermal detection | Use or unuse of thermal detection selectable | Thermal check ON | | |
| Setting of judgement temperature | 150°C or 125°C or 100°C selectable | Judgement Temperature 150°C 125°C 100°C | | |
| Gain setting | +6dB or +12dB selectable | Gain +6dB +12dB | | |
| SCK0 pin setting | "H" input or "L" input of default selectable | Clock polarity Nomal(H Level) Reversal(L Level) | | |
| SIN0 pin setting | LSB first or MSB first selectable | SPI Setting Data transfer type LSB first MSB first | | |
| Setting of use or unuse of SEQ0,3-6 pins | Use or unuse of the SEQ output of SEQ0,3-6 pins selectable (SEQ0 pin can specify only the "use") | SEQ Pins Setting SEQ3-6 Use of SEQ3-6 | | |
| Setting of the initial value of SEQ0,3-6 pin output | "L" output, or "H" output state selectable (SEQ0 pin can specify only the "L" output) | SEQ Pins Setting SEQ3-6 Initial State L level Output H level Output | | |
| Setting of SEQ0,3-6 pin output | As for the "CMOS" output setting, the "L" level output becomes "L" level and the "H" level output becomes "H" level output. As for the "Nch open drain" output setting, the "L" level output becomes "L" level and the "H" level output becomes "Hi-Z" output. As for the "Pch open drain" output setting, the "H" level output becomes "H" level and the "L" level output becomes "Hi-Z" output. As for the "Hi-Z" output setting always becomes "Hi-Z". Set when the output is open. (SEQ0 pin can specify only the CMOS output) And SEQ3-6 can be set for the LED drive pins. | SEQ Pins Setting SEQ3-6 Condtion CMOS Nch Open Drain Pch Open Drain Hi-Z | | |



Voice Synthesis Algorithm

Five types of voice synthesis algorithm are supported. They are 4-bit ADPCM2, 8-bit non-linear PCM, 8-bit straight PCM and 16-bit straight PCM. Select the best one according to the characteristics of voice. The following table shows key features of each algorithm.

| Voice synthesis algorithm | Feature |
|---------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------|
| HQ- ADPCM | Algorithm that enables high sound quality and high compression, which have been achieved by the improved 4-bit ADPCM that uses variable bit-length coding. |
| 4-bit ADPCM2 | Up version of LAPIS Semiconductor's specific voice synthesis algorithm (: 4-bit ADPCM). Voice quality is improved. |
| 8-bit Nonlinear PCM | Algorithm, which plays back mid-range of waveform as 10-bit equivalent voice quality. |
| 8-bit PCM | Normal 8-bit PCM algorithm |
| 16-bit PCM | Normal 16-bit PCM algorithm |

Memory Allocation and Creating Voice Data

The ROM is partitioned into four data areas: voice (i.e., phrase) control area, test area, voice area, and edit ROM area.

The voice control area manages the voice data in the ROM. It contains data for controlling the start/stop addresses of voice data for 30 phrases, use/non-use of the edit ROM function and so on.

The test area contains data for testing.

The voice area contains actual waveform data.

The edit ROM area contains data for effective use of voice data. For the details, refer to the section of "Edit ROM Function." The edit ROM area is not available if the edit ROM is not used.

The ROM data is created using a dedicated tool.

Configuration of ML22(Q)330 ROM data

| 0x00000 | Prohibition of use area (Fixed 128 Kbits) |
|--------------|----------------------------------------------|
| 0x03FFF | (== == ===== |
| 0x04000 | |
| | Voice area 2 |
| max. 0x0FBFF | |
| | Edit ROM area |
| | Depends on creation |
| max. 0x0FBFF | of ROM data. |
| 0x0FC00 | Test area |
| 0x0FFFF | 1631 4164 |
| 0x10000 | Voice control area |
| | (Fixed 12 Kbits) |
| 0x105FF | (1 IACG 12 NDIES) |
| 0x10600 | |
| | Voice area 1 |
| 0x17FFF | |
| | |

Configuration of ML22(Q)331 ROM data

| 0x00000 | Prohibition of use area |
|--------------------|-------------------------|
| 0x03FFF | (Fixed 128 Kbits) |
| 0x04000 | Voice area 2 |
| max. 0x0FBFF | |
| | Edit ROM area |
| | Depends on creation |
| max. 0x0FBFF | of ROM data. |
| 0x0FC00 0x0FFFF | Test area |
| 0x10000 | Voice control area |
| 0x105FF | (Fixed 12 Kbits) |
| 0x10600 | |
| | Voice area 1 |
| 0x1FFFF | |

The one phrase must make 50ms or more length.

Since the data which exceeds 64 K bytes in one phrage cannot be played, please devide the voice phrase to be set to each below 64 K bytes, and join those data by the edit phrase function.



Playback Time and Memory Capacity

The playback time depends on the memory capacity, sampling frequency, and the playback method. The equation to know the playback time is shown below. But this is not applied if the edit ROM function is used.

Playback time [sec] =
$$\frac{1.024 \times (\text{Voice area 1 + Voice area 2}) \text{ [Kbits]}}{\text{Sampling frequency [kHz]} \times \text{Bit length}}$$

(Bit length is 4 at the 4-bit ADPCM2 and 8/16 at the PCM.)

Example) In the case that the sampling frequency is 8 kHz, algorithm is 4-bit ADPCM2, the playback time is approx. 29.4 seconds, as shown below.

Playback time =
$$\frac{1.024 \times 876 \text{ [Kbits]}}{8 \text{ [kHz]} \times 4 \text{ [bits]}} \cong 28.0 \text{ [sec]}$$

Edit ROM Function

The edit ROM function makes it possible to play back multiple phrases in succession. The following functions are set using the edit ROM function:

• Continuous playback: There is no limit to set the number of times of the continuous playback. It depends on the

memory capacity only.

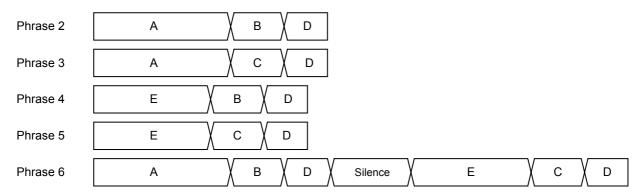
• Silence insertion function: 20ms to 1,024 ms (4ms unit)

Note: Silent insertion time varies for ± 1 ms by the sampling frequency

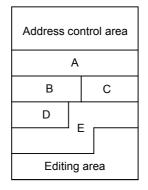
Note: At the change immediately mode, the silence insertion function cannot use.

It is possible to use voice ROM effectively to use the edit ROM function. Below is an example of the ROM structure, case of using the edit ROM function.

Example 1) Phrases using the Edit ROM Function



Example 2) Structure of the ROM that contents of Example 1 are stored



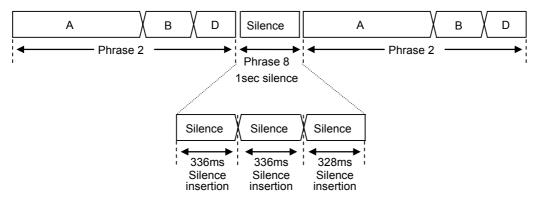


Notice of silence insertion function

If it is only silence phrase registered, please put in order three or more silence phrase. The phrase which is constituted from one or two of silence phrase does not playback.

Example 3) Phrase composition in the case of using silence insertion function

The phrase to playback (The phrase 2 is playbacked twice on both sides of 1 sec silence.)



1 sec which is constituted by the three silences is registered as the phrase 8.

The ROM consumption when using the edit ROM function

When playing more than one phrases continuously, the ROM consumption is used 64 bits per 1 phrase. The silence insertion function is used 16 bits every once.



TERMINATION OF THE V_{DDL} PIN

The V_{DDL} pin is the regulator output that is power supply pin for the internal logic circuits. Connect a capacitor between this pin and the ground in order to prevent noise generation and power fluctuation.

The recommended capacitance value is shown below. However, it is important to evaluate and decide using the own board. Also, start the next operation after each output voltage is stabilized.

| Pin | Recommended capacitance value | Remarks |
|-----------|-------------------------------|----------------------------------------------------------------------|
| V_{DDL} | 10 μF ±20% | The larger the connection capacitance, the longer the settling time. |

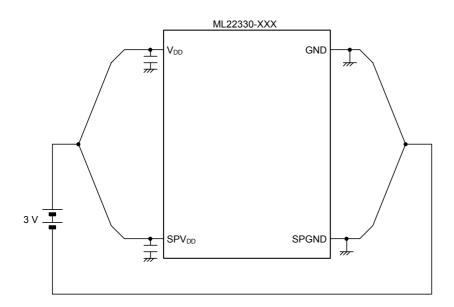
POWER SUPPLY WIRING

The power supply of this LSI is divided into the following sections:

- Digital power supply (V_{DD})
- Analog power supply (SPV_{DD})

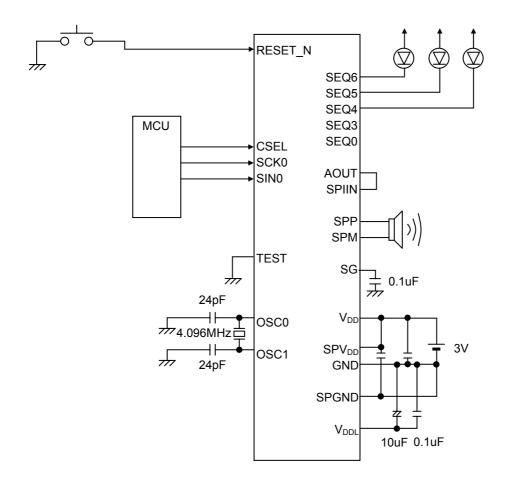
As shown below, supply the same power supply to V_{DD} and SPV_{DD} and separate the analog and digital power supplies by wiring.

Power supply voltage = 3 V



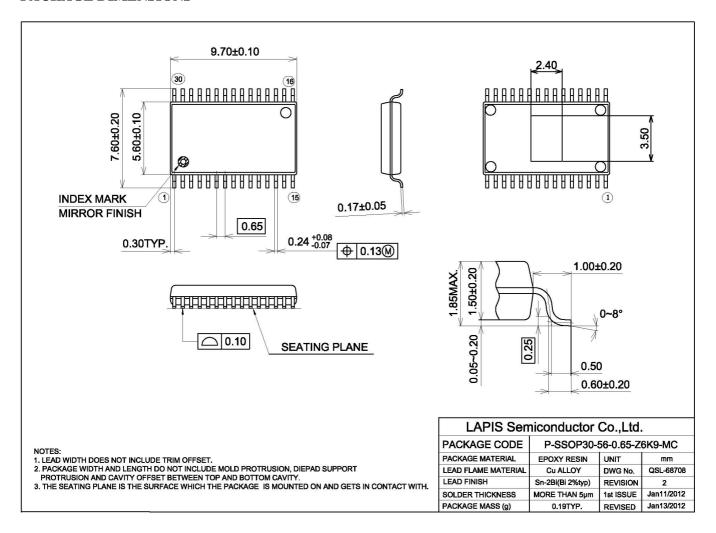


EXAMPLE OF APPLICATION CIRCUIT





PACKAGE DIMENSIONS



Notes for Mounting the Surface Mount Type Package

The surface mount type packages are very susceptible to heat in reflow mounting and humidity absorbed in storage. Therefore, before you perform reflow mounting, contact ROHM's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

The heat resistance (example) of this LSI is shown below. Heat resistance (θ Ja) changes with the size and the number of layers of a substrate.

| Strate. | |
|--------------------------------------------------------------|-------------------------------------|
| Die pad on the back of a package partial ground contact area | 100% |
| PCB | JEDEC (W/L/t=76.2/114.5/1.6(mm)) |
| PCB Layer | 4L |
| Air cooling conditions | Calm (0m/sec) |
| Heat resistance(θJa) | 45[°C/W] |
| Power consumption of Chip PMax at OutputPower 1W (5V) | 0.818[W] |
| Power consumption of Chip PMax at OutputPower 0.5W (3.3V) | 0.283[W] |

TjMax of this LSI is 125°C. TjMax is expressed with the following formulas.

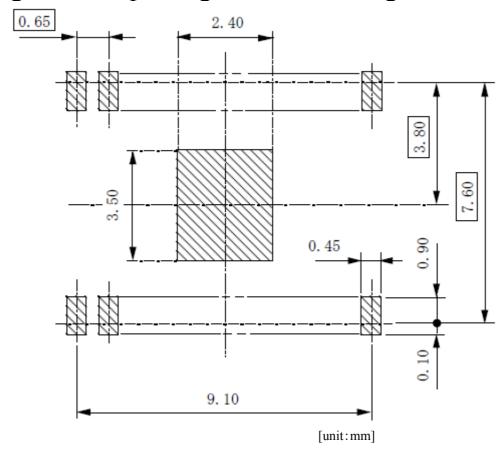
 $TjMax = TaMax + \theta Ja \times PMax$



Mounting area for package lead soldering to PCB (reference data) is shown below.

Die pad on the back of a package should connect with the substrate of opening or a GND for heat dissipation.

Mounting area for package lead soldering to PC boards



When laying out PC boards, it is important to design the foot pattern so as to give consideration to ease of mounting, bonding, positioning of parts, reliability, writing, and elimination of solder bridges.

The optimum design for the foot pattern varies with the materials of the substrate, the sort and thickness of used soldering paste, and the way of soldering. Therefore when laying out the foot pattern on the PC boards, refer to this figure which mean themounting area that the package leads are allowable for soldering to PC boards.



REVISION HISTORY

| Degument | | Pa | ge | | | | | | |
|-----------------|---------------|---------------------|--------------------|-----------------------------------------------------------------------------------|-------------------------------------------------------------------|-----------------------------------------------------------------|--|----|---|
| Document No. | Date | Previous Edition | Current Edition | Description | | | | | |
| FEDL22330-01 | Dec. 12, 2012 | _ | _ | Final edition 1 | | | | | |
| | | 1,2,3 | 1,2,3 | Change ROM size 640K(896K) -> 620K(876K) | | | | | |
| | | 1 | 1 | Change Playback Time. | | | | | |
| | | 9 | 6 | Power dissipation W -> mW | | | | | |
| | | 9 | 6 | Digital power supply voltage 2.7 to 5.5 -> 3.0 to 5.5 | | | | | |
| | | 9 | 6 | Flash memory rewrite cycles 80 -> 80 times | | | | | |
| | | 9 | 6 | Operating temperature T_{OP2} -20 to +70°C -> -40 to +85°C | | | | | |
| | Mar. 23,2015 | 10 | 7 | "H" output voltage 2 V _{OH2} OSC2 -> OSC1 | | | | | |
| | | 10 | 7 | "L" output voltage 4 V _{OL4} LED mode selected -> When the LED drives | | | | | |
| | | 10 | _ | Delete the I _{IH3} | | | | | |
| | | _ | 7 | Add the I _{IL3} . | | | | | |
| FEDL22330-02 | | Mar. 23,2015 | Mar. 23,2015 | 11 | 8 | AOUT output load resistance R _{LAO} -> R _{LA} | | | |
| | | | | | | | | 11 | 8 |
| | | | 11 | 8 | AOUT output voltage range V _{AOUT} -> V _{AO} | | | | |
| | | | 11 | 8 | Speaker amplifier output power 1.26W -> 1W | | | | |
| | | 11 | 8 | Initialize time Min:-/Max:2ms -> Min:20ms/Max:22ms | | | | | |
| | | - | 8 | Add the notice of "Disconnection judging time by the DISCONNECT event". | | | | | |
| | | 14 | 9 | Changes the starting point of "tosc." | | | | | |
| | | _ | 13 | Add the notice of "Synchronous Serial Event Interface." | | | | | |
| | | _ | 14 | Add the description of "Playback mode setup". | | | | | |
| | | _ | 14 | Add the notice of "Event List". | | | | | |
| | | - | 15 | Add the description of "Event Functions". | | | | | |



| Dogument | | Page | | |
|-----------------|------|---------------------|--------------------|--------------------------------------------------------------------------------------|
| Document No. | Date | Previous Edition | Current Edition | Description |
| | | _ | 20 | Add the notice of "Pulse output". |
| | | _ | 21 | Add the table of "Pulse Width and Delay Time". |
| | | _ | 22 | Add the table of "repetition Number". |
| | | _ | 26 | Add the "Wait time setting before and after playback (WS1, WS2, WS3, WS4)" |
| | | _ | 27 | Add the table of "Wait time setting before and after playback (WS1, WS2, WS3, WS4)". |
| | | 3 | 29 | Change the "Setting of Mask Option". |
| | | _ | 30 | Add the description of "Voice Synthesis Algorithm". |
| | | _ | 30 | Add the notice of "Memory Allocation and Creating Voice Data". |
| | | _ | 30 | Add the description of "minimal playback time". |
| | | _ | 31 | Add the description of "Playback Time and Memory Capacity". |
| | | _ | 31 | Add the description of "Edit ROM Function". |
| | | _ | 32 | Add the notice of the "silence insertion function". |
| | | _ | 32 | Add the notice of "ROM consumption when using the edit ROM function". |
| | | _ | 33 | Add the notice of "TERMINATION OF THE V _{DDL} PIN". |
| | | 25 | 34 | EXAMPLE OF APPLICATION CIRCUIT DV _{DD} -> VDD |
| | | 25 | 34 | EXAMPLE OF APPLICATION CIRCUIT DV _{SS} -> GND |
| | | 25 | 34 | EXAMPLE OF APPLICATION CIRCUIT SPV _{SS} -> SPGND |
| | | 26 | 35 | Changes the "package dimensions". |
| | | 27 | 36 | The connection between the die pad and the substrate V_{SS} -> GND |



NOTES

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2-4-8 Shinyokohama, Kouhoku-ku, Yokohama 222-8575, Japan http://www.lapis-semi.com/en/